

Schottky Barrier Diode Silicon Epitaxial

CUS15S40

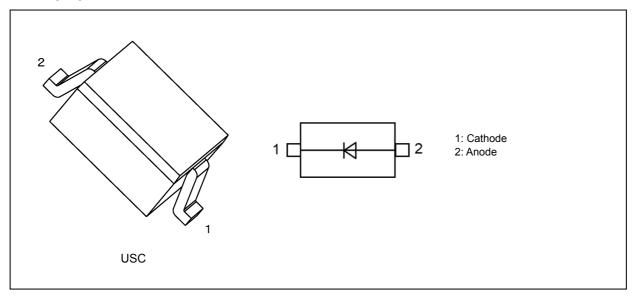
1. Applications

· High-Speed Switching

2. Features

- (1) Small package
- (2) Low forward voltage: $V_F(2) = 0.47 \text{ V (typ.)}$

3. Packaging and Internal Circuit



1



4. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Rating	Unit
Peak reverse voltage	V _{RM}		40	V
Reverse voltage	V _R		30	V
Average rectified current	I _O	(Note 1)	1.5	Α
Non-repetitive peak forward surge current	I _{FSM}	(Note 2)	5	Α
Junction temperature	Tj		125	°C
Storage temperature	T _{stg}		-55 to 125	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on an FR4 board.

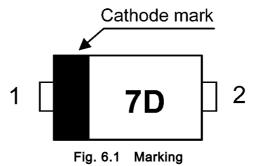
 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{ mm}, \text{Cu Pad: } 645 \text{ mm}^2)$

Note 2: Pulse width 10 ms

5. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _F (1)	I _F = 1 A (Pulse test)	_	0.40	0.45	V
Forward voltage	V _F (2)	I _F = 1.5 A (Pulse test)	_	0.47	0.55	V
Reverse current	I _R	V _R = 40 V (Pulse test)	_	_	200	μА
Total capacitance	Ct	V _R = 0 V, f = 1 MHz	_	170	_	pF

6. Marking



Marking Code	Part Number		
7D	CUS15S40		



7. Usage Considerations

Schottky barrier diodes (SBDs) have reverse leakage greater than other types of diodes. This makes SBDs more susceptible to thermal runaway under high-temperature and high-voltage conditions. Thus, both forward and reverse power losses of SBDs should be considered for thermal and safety design.

8. Land Pattern Dimensions (for reference only)

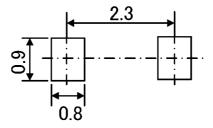


Fig. 8.1 Land Pattern Dimensions for Reference Only (Unit: mm)



9. Characteristics Curves (Note)

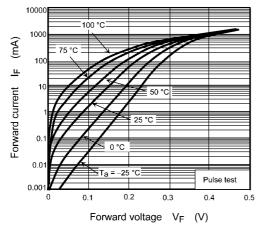


Fig. 9.1 I_F - V_F

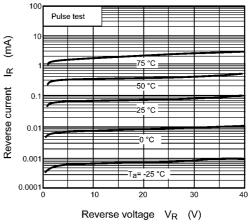


Fig. 9.2 I_R - V_R

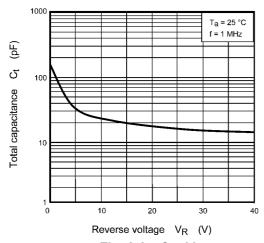


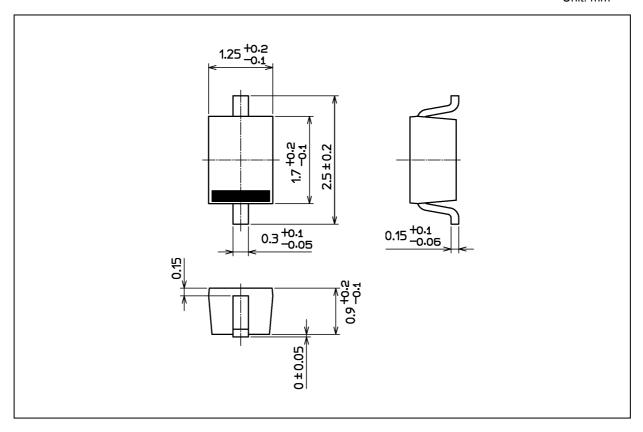
Fig. 9.3 Ct - VR

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 4.5 mg (typ.)

Package Name(s)			
Nickname: USC			



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